

CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

17 July 2023

Issue Number 230208 Tender Type Reopening **Tender Date** 18 July 2023 9:30 am to 10:30 am **Tender Time** Renminbi 8 Billion Offering Amount Interest Type Fixed 2.52% Coupon Rate **Interest Payment Frequency** Annually **Interest Payment Date** 25 May Original Tenor Five Years Maturity Date 25 May 2028 20 July 2023 Issue and Settlement Date 25 May 2023 Dated Date(Value Date) 24 July 2023 Listing Date Clearing House China Central Depository & Clearing Co.,Ltd China's Inter-bank Bond Market(CIBM) Market Exempted for issuance in CIBM Rating

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

*Disclaimer

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CDB's bond yield curve available at http://www.cdb.com.cn.